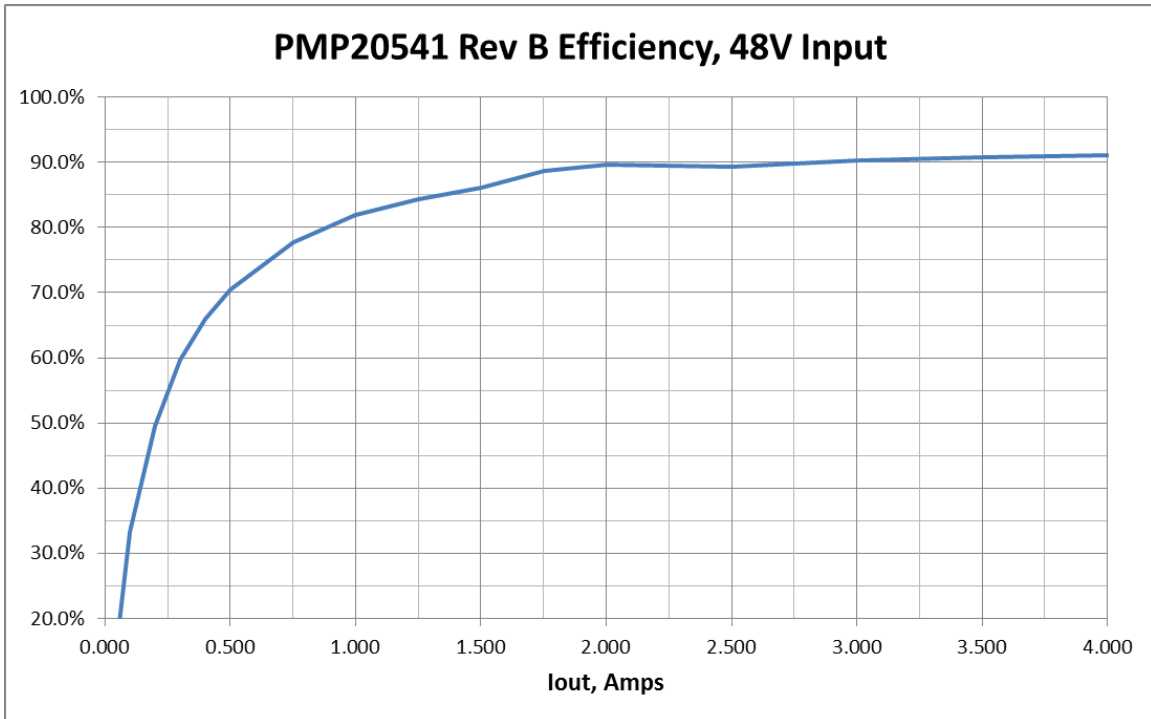


Testing performed with 54V input, 4A load and 20MHz bandwidth unless noted.

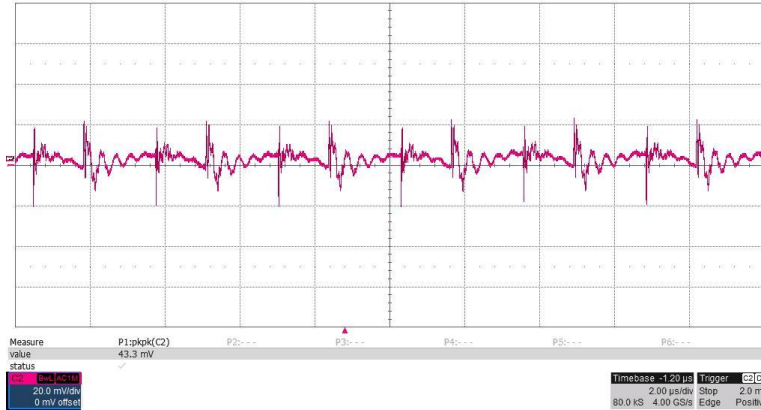
**Efficiency**

<b>J2</b> <b>I<sub>out</sub></b>	<b>J2</b> <b>V<sub>out</sub></b>	<b>J1</b> <b>I<sub>in</sub></b>	<b>J1</b> <b>V<sub>in</sub></b>	<b>J1</b> <b>Eff</b>
0.000	12.030	0.044	54.00	0.0%
0.100	12.030	0.067	54.00	33.3%
0.200	12.030	0.090	54.00	49.5%
0.300	12.030	0.112	54.00	59.7%
0.400	12.029	0.135	54.00	66.0%
0.500	12.029	0.158	54.00	70.5%
0.750	12.028	0.215	54.00	77.7%
1.000	12.028	0.272	54.00	81.9%
1.250	12.027	0.330	54.00	84.4%
1.500	12.027	0.388	54.00	86.1%
1.750	12.206	0.446	54.00	88.7%
2.000	12.206	0.504	54.00	89.7%
2.500	12.024	0.623	54.00	89.4%
3.000	12.023	0.740	54.00	90.3%
3.500	12.021	0.859	54.00	90.7%
4.000	12.020	0.978	54.00	91.0%



**Ripple and Noise**

Output ripple, 20mV/div, 2usec/div, measured 43.3mVpp across C14:

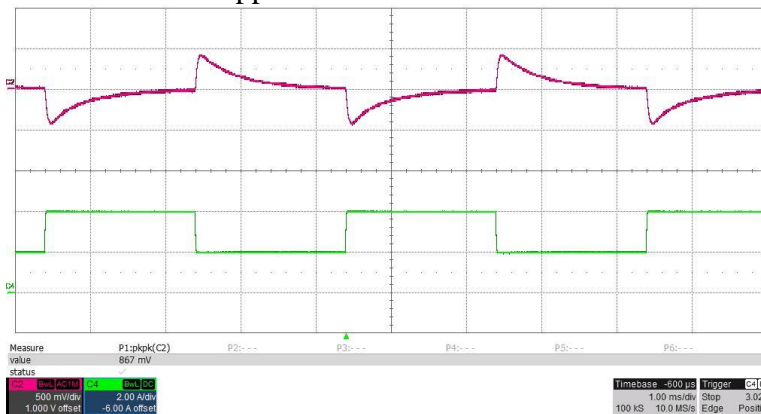


Input ripple, 20mV/div, 2usec/div, measured 33.3mVpp across C3:



### Dynamic Loading

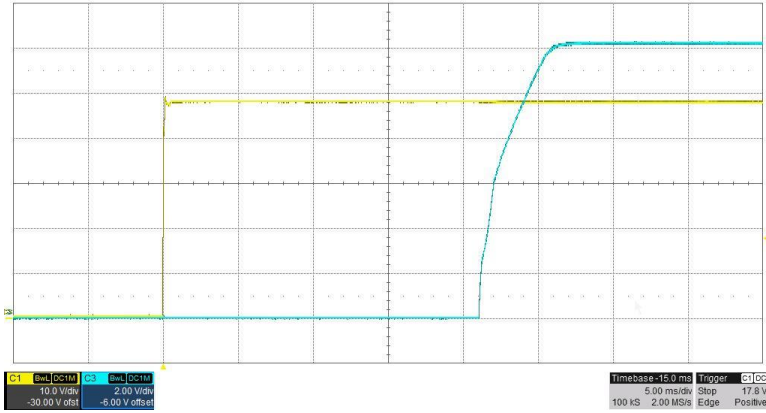
Output load step response, 2A to 4A load step  
500mV/div, 2A/div, 1msec/div, slew rate = 400mA/usec  
Measured 867mVpp across C14:



**Turn On Response**

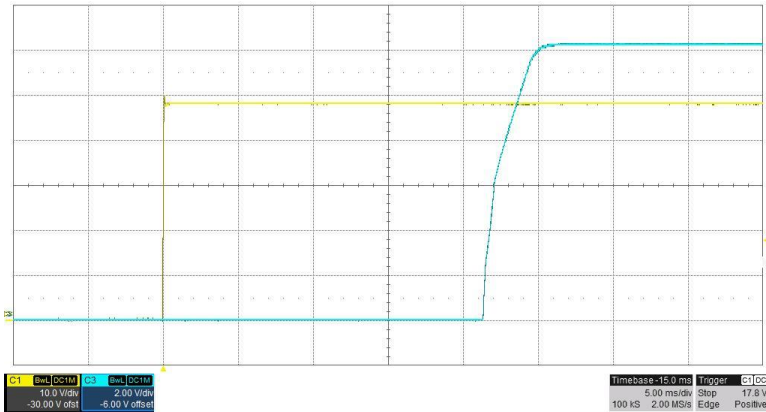
4A load, 5msec/div

CH1= Vin, 10V/div; CH2=Vout, 2V/div:



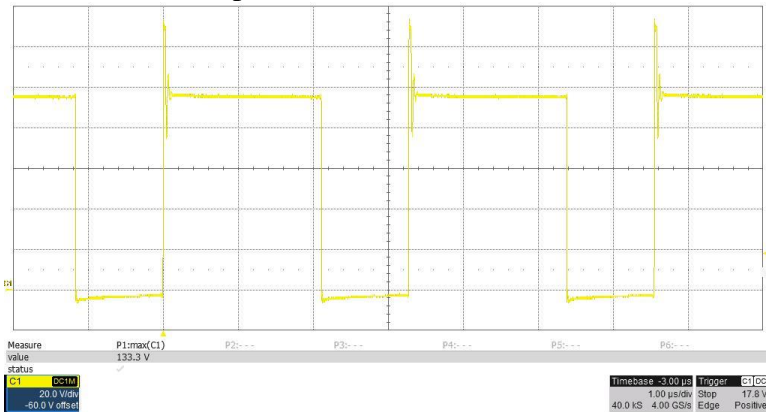
0A load, 5msec/div

CH1= Vin, 10V/div; CH2=Vout, 2V/div:

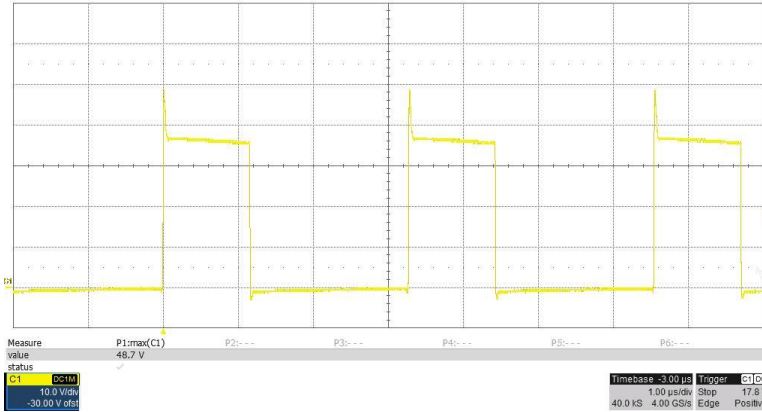


**Waveforms**

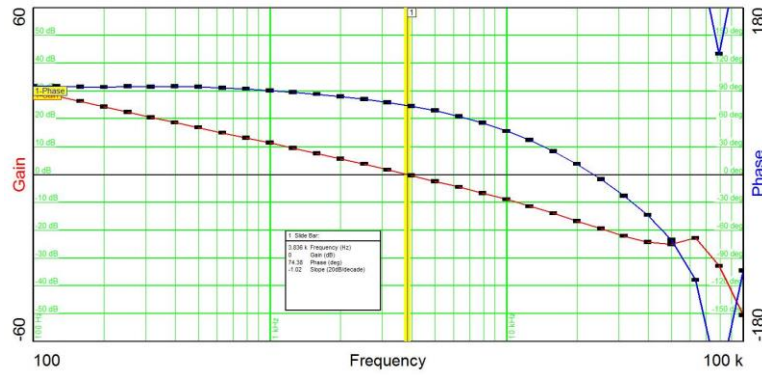
Vds, Q1, 20V/div, 1usec/div, 60Vdc input, 750MHz bandwidth  
Measured 133.3Vpeak:



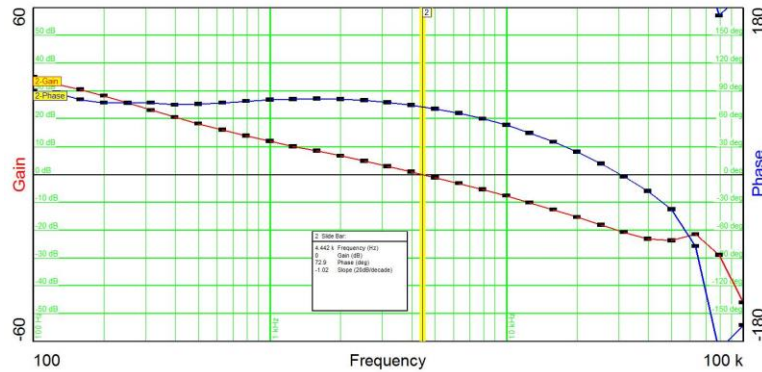
V<sub>ds</sub>, Q3, 10V/div, 1usec/div, 60Vdc input, 750MHz bandwidth  
 Measured 48.7Vpeak:



**Loop Stability**

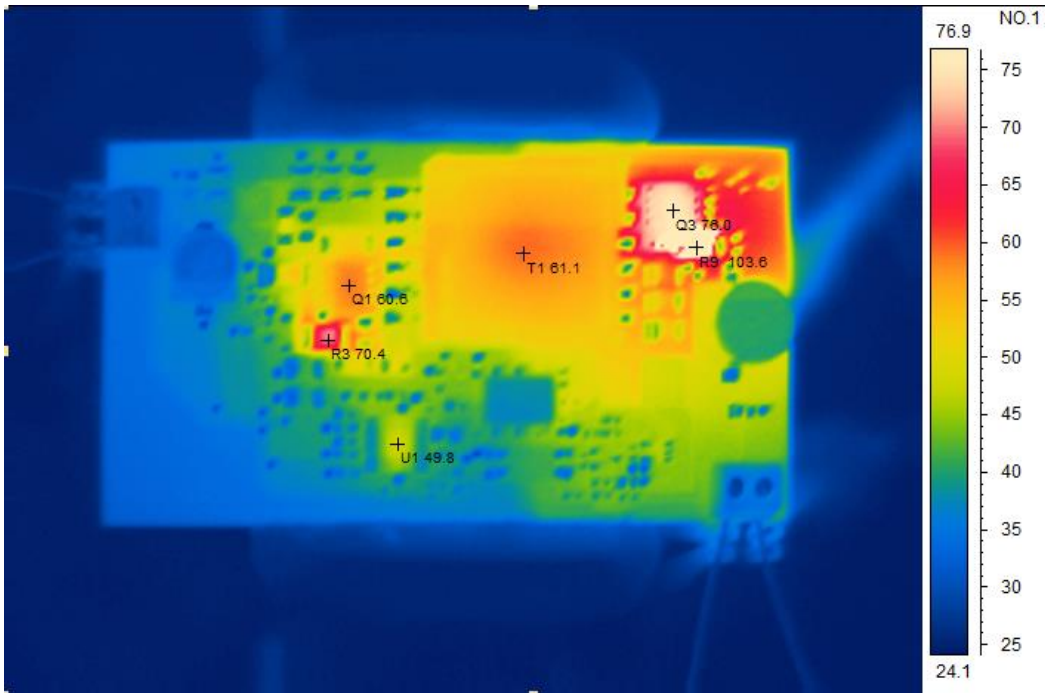


4A Load: Bandwidth= 3.8 kHz Phase Margin=74 degrees Gain Margin=18dB

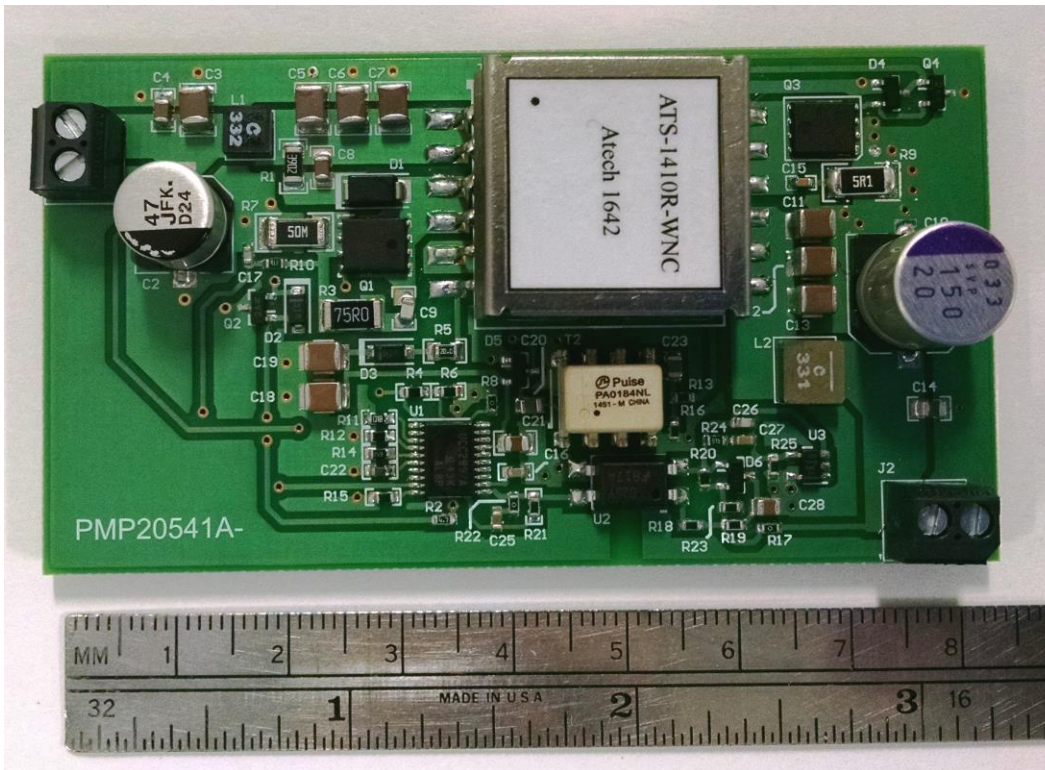


400mA Load: Bandwidth= 4.4 kHz Phase Margin=73 degrees Gain Margin=20dB

Thermal Plots



Photo



## IMPORTANT NOTICE FOR TI DESIGN INFORMATION AND RESOURCES

Texas Instruments Incorporated ("TI") technical, application or other design advice, services or information, including, but not limited to, reference designs and materials relating to evaluation modules, (collectively, "TI Resources") are intended to assist designers who are developing applications that incorporate TI products; by downloading, accessing or using any particular TI Resource in any way, you (individually or, if you are acting on behalf of a company, your company) agree to use it solely for this purpose and subject to the terms of this Notice.

TI's provision of TI Resources does not expand or otherwise alter TI's applicable published warranties or warranty disclaimers for TI products, and no additional obligations or liabilities arise from TI providing such TI Resources. TI reserves the right to make corrections, enhancements, improvements and other changes to its TI Resources.

You understand and agree that you remain responsible for using your independent analysis, evaluation and judgment in designing your applications and that you have full and exclusive responsibility to assure the safety of your applications and compliance of your applications (and of all TI products used in or for your applications) with all applicable regulations, laws and other applicable requirements. You represent that, with respect to your applications, you have all the necessary expertise to create and implement safeguards that (1) anticipate dangerous consequences of failures, (2) monitor failures and their consequences, and (3) lessen the likelihood of failures that might cause harm and take appropriate actions. You agree that prior to using or distributing any applications that include TI products, you will thoroughly test such applications and the functionality of such TI products as used in such applications. TI has not conducted any testing other than that specifically described in the published documentation for a particular TI Resource.

You are authorized to use, copy and modify any individual TI Resource only in connection with the development of applications that include the TI product(s) identified in such TI Resource. NO OTHER LICENSE, EXPRESS OR IMPLIED, BY ESTOPPEL OR OTHERWISE TO ANY OTHER TI INTELLECTUAL PROPERTY RIGHT, AND NO LICENSE TO ANY TECHNOLOGY OR INTELLECTUAL PROPERTY RIGHT OF TI OR ANY THIRD PARTY IS GRANTED HEREIN, including but not limited to any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information regarding or referencing third-party products or services does not constitute a license to use such products or services, or a warranty or endorsement thereof. Use of TI Resources may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

TI RESOURCES ARE PROVIDED "AS IS" AND WITH ALL FAULTS. TI DISCLAIMS ALL OTHER WARRANTIES OR REPRESENTATIONS, EXPRESS OR IMPLIED, REGARDING TI RESOURCES OR USE THEREOF, INCLUDING BUT NOT LIMITED TO ACCURACY OR COMPLETENESS, TITLE, ANY EPIDEMIC FAILURE WARRANTY AND ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, AND NON-INFRINGEMENT OF ANY THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

TI SHALL NOT BE LIABLE FOR AND SHALL NOT DEFEND OR INDEMNIFY YOU AGAINST ANY CLAIM, INCLUDING BUT NOT LIMITED TO ANY INFRINGEMENT CLAIM THAT RELATES TO OR IS BASED ON ANY COMBINATION OF PRODUCTS EVEN IF DESCRIBED IN TI RESOURCES OR OTHERWISE. IN NO EVENT SHALL TI BE LIABLE FOR ANY ACTUAL, DIRECT, SPECIAL, COLLATERAL, INDIRECT, PUNITIVE, INCIDENTAL, CONSEQUENTIAL OR EXEMPLARY DAMAGES IN CONNECTION WITH OR ARISING OUT OF TI RESOURCES OR USE THEREOF, AND REGARDLESS OF WHETHER TI HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

You agree to fully indemnify TI and its representatives against any damages, costs, losses, and/or liabilities arising out of your non-compliance with the terms and provisions of this Notice.

This Notice applies to TI Resources. Additional terms apply to the use and purchase of certain types of materials, TI products and services. These include; without limitation, TI's standard terms for semiconductor products (<http://www.ti.com/sc/docs/stdterms.htm>), [evaluation modules](#), and [samples](http://www.ti.com/sc/docs/sampterm.htm) (<http://www.ti.com/sc/docs/sampterm.htm>).

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
Copyright © 2017, Texas Instruments Incorporated